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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: DeWitt, Jr. et al.

§ Group Art Unit: 2183

Serial No.: 10/675,778

§ Examiner: Cody, Dillon J.

Filed: September 30, 2003

§ Attorney Docket No.: AUS920030480US1

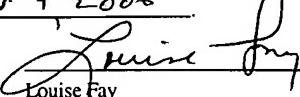
For: Method and Apparatus for
Counting Data Accesses and
Instruction Executions that Exceed a
Threshold

35525

PATENT TRADEMARK OFFICE
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- Reference AC; and
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Respectfully submitted,



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In re application of:

DeWitt, Jr. et al.

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Title: Method and Apparatus for Counting
Data Accesses and Instruction Executions
that Exceed a Threshold

Group Art Unit: 2183

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International Business
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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants submit herewith patents, publications or other information of which they are aware, which they believe may be material to the patentability of this application and in respect of which there may be a duty to disclose in accordance with 37 C.F.R. 1.56.

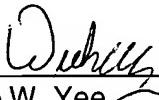
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Respectfully submitted,



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